OFFICIAL

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Yoshino

Docket No: TI-29448

Serial No:

09/909,013

Examiner:

Geyer, Scott

Filed:

7/19/2001

Art Unit:

2829

For:

SEMICONDUCTOR PACKAGE INSULATION FILM AND

MANUFACTURING METHOD THEREOF

AMENDMENT UNDER 37 C.F.R. § 1.115

Assistant Commissioner For Patents Washington, DC 20231

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark

Office at 703-872-9306 on

Dear Sir:

Responsive to the Office Action mailed February 27, 2004 in connection with the above identified application, Applicants respectfully submit the following amendments and remarks.